

MPF521

CASE 317-01, STYLE 1

**MOSFET
DUAL GATE
VHF AMPLIFIER TRANSISTOR**

N-CHANNEL — ENHANCEMENT

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	25	Vdc
Drain-Gate Voltage	V_{DG1} V_{DG2}	30 30	Vdc
Drain Current	I_D	30	mAdc
Gate Current	I_{G1F} I_{G2F}	10 10	mAdc
Total Device Dissipation (at $T_A = 25^\circ\text{C}$ Derate above 25°C)	P_D	300 1.71	mW mW/ $^\circ\text{C}$
Operating Channel Temperature	T_{channel}	150	$^\circ\text{C}$
Lead Temperature, 1/16" From Seated Surface for 10 Seconds	T_L	200	$^\circ\text{C}$
Storage Channel Temperature Range	T_{stg}	-65 to +150	$^\circ\text{C}$

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Gate 1-Source Breakdown Voltage ($V_{G2} = V_{DS} = 0$, $I_{G1} = 10 \mu\text{Adc}$)	$V_{(BR)G1SO}$	10	15	—	Vdc
Gate 2-Source Breakdown Voltage ($V_{G1S} = V_{DS} = 0$, $I_{G2} = 10 \mu\text{Adc}$)	$V_{(BR)G2SO}$	12	16	—	Vdc
Gate 1 Reverse Leakage Current ($V_{G1S} = 5.0 \text{ Vdc}$, $V_{G2S} = V_{DS} = 0$)	I_{G1SS}	—	30	100	nAdc
Gate 2 Reverse Leakage Current ($V_{G2S} = 5.0 \text{ Vdc}$, $V_{G1S} = V_{DS} = 0$)	I_{G2SS}	—	30	100	nAdc
Drain-Source Breakdown Voltage ($V_{G2} = 0$, $I_D = 10 \mu\text{Adc}$)	$V_{(BR)DS}$	25	28	—	Vdc

ON CHARACTERISTICS

Gate-Source Threshold Voltage ($V_{G2S} = 10 \text{ Vdc}$, $I_D = 10 \mu\text{Adc}$, $V_{DS} = 15 \text{ V}$) ($V_{G1S} = 4.0 \text{ Vdc}$, $I_D = 10 \mu\text{Adc}$, $V_{DS} = 15 \text{ V}$)	$V_{G1S(TH)}$ $V_{G2S(TH)}$	0.5 0.5	1.2 1.0	2.0 2.0	Vdc
Gate-Source On Voltage ($V_{DS} = 15 \text{ Vdc}$, $V_{G2S} = 10 \text{ Vdc}$, $I_D = 10 \text{ mAdc}$)	$V_{G1S(on)}$	2.0	2.6	4.0	Vdc
"On" Drain Current ($V_{DS} = 15 \text{ Vdc}$, $V_{G2S} = 10 \text{ Vdc}$, $V_{G1S} = 3.0 \text{ Vdc}$)	$I_{D(on)}$	5.0	15	20	mAdc

SMALL-SIGNAL CHARACTERISTICS

Forward Transfer Admittance(1) ($V_{DS} = 15 \text{ Vdc}$, $V_{G2S} = 10 \text{ Vdc}$, $I_D = 10 \text{ mAdc}$, $f = 1.0 \text{ kHz}$) ($V_{DS} = 15 \text{ Vdc}$, $V_{G2S} = 10 \text{ Vdc}$, $I_D = 10 \text{ mAdc}$, $f = 200 \text{ MHz}$)	$ Y_{fs} $ Y_{fs}	10 —	12 10.57-j6.86	20 —	mmhos
Input Admittance(1) ($V_{DS} = 15 \text{ Vdc}$, $V_{G2S} = 10 \text{ Vdc}$, $I_D = 10 \text{ mAdc}$, $f = 200 \text{ MHz}$)	Y_{is}	—	0.524 + j4.27	—	mmhos
Reverse Transfer Admittance(1) ($V_{DS} = 15 \text{ Vdc}$, $V_{G2S} = 10 \text{ Vdc}$, $I_D = 10 \text{ mAdc}$, $f = 200 \text{ MHz}$)	Y_{rs}	—	-1.7-j9.8	—	μmhos
Output Admittance(1) ($V_{DS} = 15 \text{ Vdc}$, $V_{G2S} = 10 \text{ Vdc}$, $I_D = 10 \text{ mAdc}$, $f = 200 \text{ MHz}$)	$ Y_{os} $	—	0.126 + j1.79	—	mmhos
Input Capacitance ($V_{DS} = 15 \text{ Vdc}$, $V_{G2S} = 10 \text{ Vdc}$, $V_{G1} = 2.5 \text{ Vdc}$, $f = 1.0 \text{ MHz}$)	C_{iss}	—	3.3	4.0	pF
Reverse Transfer Capacitance ($V_{DS} = 15 \text{ Vdc}$, $V_{G2S} = 10 \text{ Vdc}$, $V_{G1} = 2.5 \text{ Vdc}$, $f = 1.0 \text{ MHz}$)	C_{rss}	—	0.015	0.03	pF
Output Capacitance ($V_{DS} = 15 \text{ Vdc}$, $V_{G2S} = 10 \text{ Vdc}$, $V_{G1} = 2.5 \text{ Vdc}$, $f = 1.0 \text{ MHz}$)	C_{oss}	—	1.1	2.5	pF

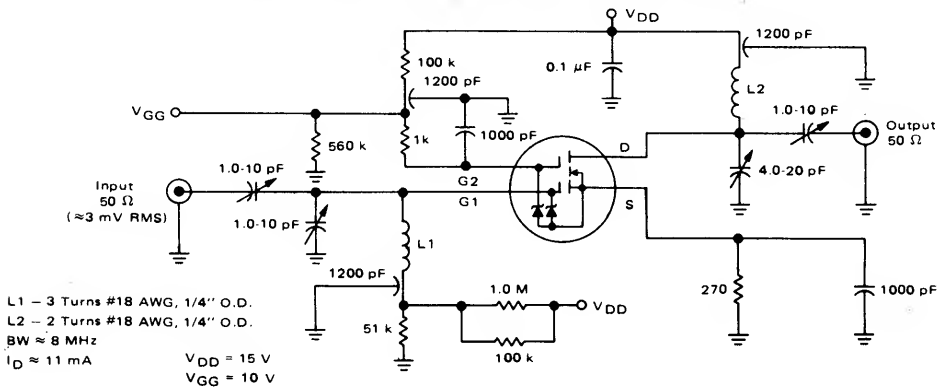
MPF521

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
FUNCTIONAL CHARACTERISTICS					
Noise Figure (Figures 1 and 9) ($V_{DS} = 15\text{ Vdc}$, $V_{GG} = 10\text{ V}$, $f = 200\text{ MHz}$)	NF	—	1.7	3.5	dB
Common Source Power Gain (Figures 1 and 9) ($V_{DS} = 15\text{ Vdc}$, $V_{GG} = 10\text{ V}$, $f = 200\text{ MHz}$, $BW = 7.0\text{ MHz (Min)}$)	G_{ps}	21	25	—	dB

(1) All y-parameters are with respect to Gate 1.

FIGURE 1 – 200 MHz NOISE FIGURE AND POWER GAIN TEST CIRCUIT



TYPICAL CHARACTERISTICS

FIGURE 2 – DRAIN CURRENT versus DRAIN to SOURCE VOLTAGE

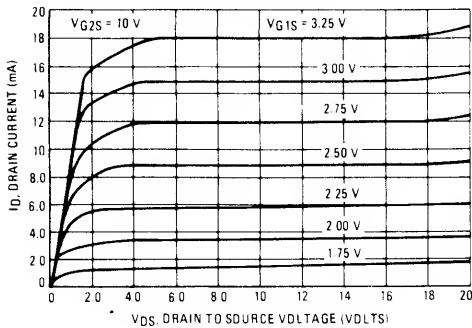


FIGURE 3 – DRAIN CURRENT versus GATE-ONE to SOURCE VOLTAGE

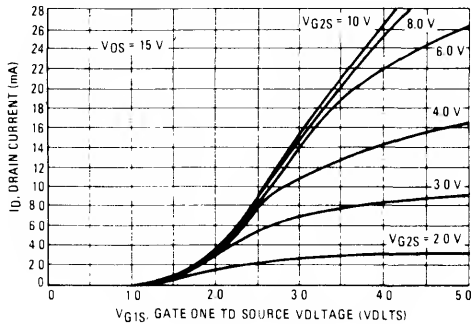


FIGURE 4 – SMALL-SIGNAL COMMON-SOURCE GATE-ONE FORWARD TRANSFER ADMITTANCE versus GATE-ONE to SOURCE VOLTAGE

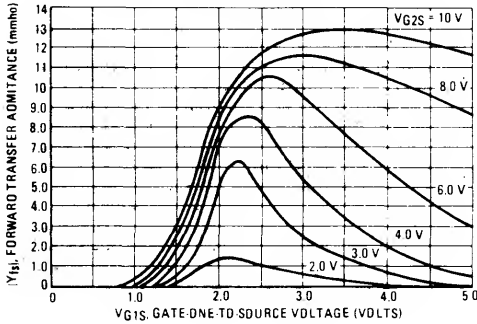


FIGURE 5 – SMALL-SIGNAL COMMON-SOURCE GATE-ONE FORWARD TRANSFER ADMITTANCE versus DRAIN CURRENT

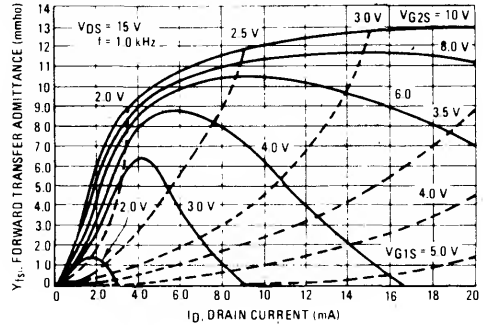


FIGURE 6 – SMALL-SIGNAL COMMON-SOURCE GATE-ONE INPUT AND OUTPUT CAPACITANCE versus GATE-TWO to SOURCE VOLTAGE

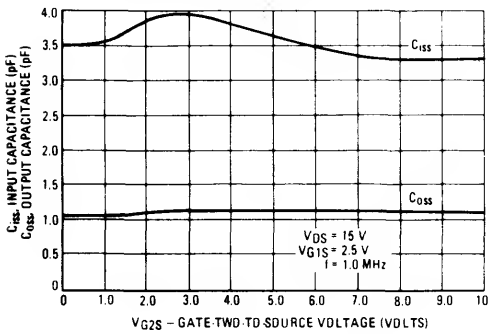


FIGURE 7 – COMMON SOURCE POWER GAIN versus DRAIN SUPPLY CURRENT

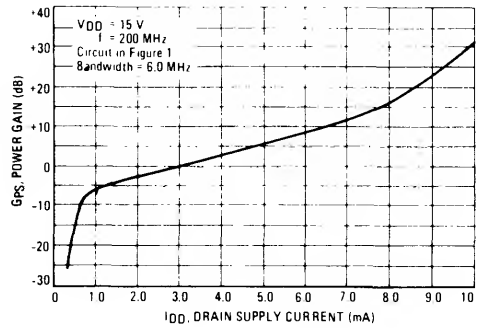


FIGURE 8 – COMMON SOURCE POWER GAIN AND SPOT NOISE FIGURE versus DRAIN CURRENT

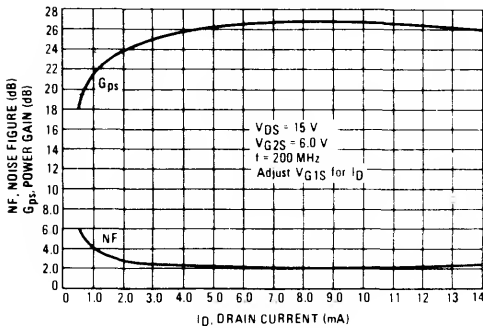


FIGURE 9 – COMMON SOURCE POWER GAIN AND SPOT NOISE FIGURE versus GAIN CONTROL GATE-SUPPLY VOLTAGE

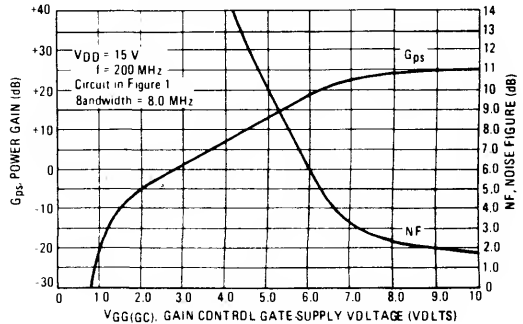


FIGURE 10 – SMALL-SIGNAL GATE ONE
INPUT ADMITTANCE versus FREQUENCY

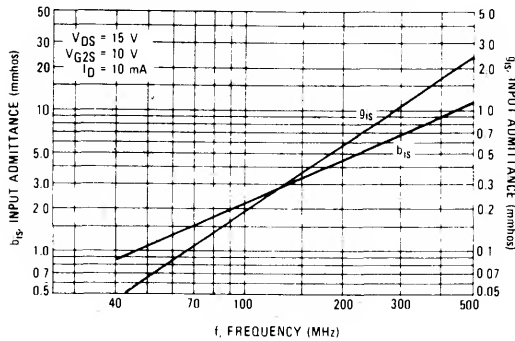


FIGURE 11 – SMALL-SIGNAL COMMON SOURCE
GATE ONE FORWARD TRANSFER
ADMITTANCE versus FREQUENCY

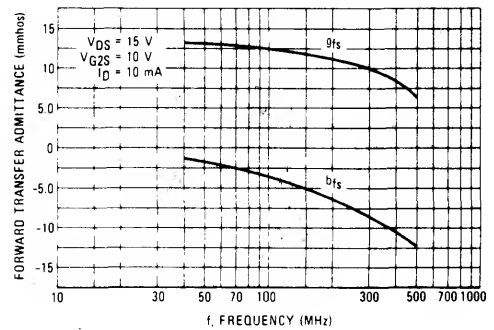


FIGURE 12 – SMALL-SIGNAL COMMON SOURCE
OUTPUT ADMITTANCE versus FREQUENCY

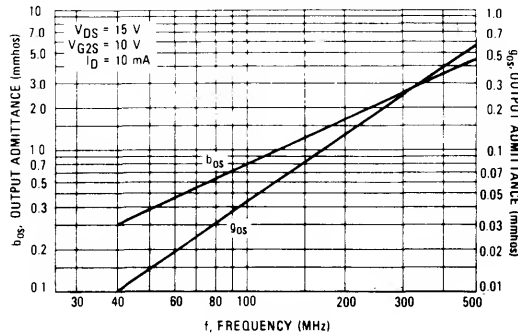


FIGURE 13 – INPUT / OUTPUT IMPEDANCE

